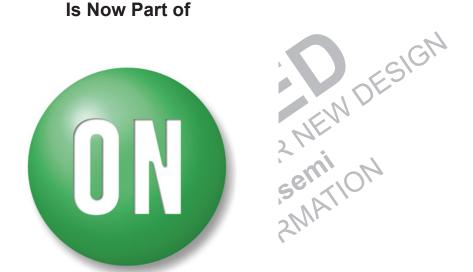


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### FDY101PZ

## Single P-Channel (- 2.5V) Specified PowerTrench® MOSFET

### **General Description**

This Single P-Channel MOSFET has been designed using Fairchild Semiconductor's advanced Power Trench process to optimize the  $R_{\text{DS}(\text{ON})}$  @  $V_{\text{GS}} = -2.5 v.$ 

### **Applications**

• Li-Ion Battery Pack



### **Features**

- -150 mA, -20 V R<sub>DS(ON)</sub> = 8  $\Omega$  @ V<sub>GS</sub> = -4.5 V R<sub>DS(ON)</sub> = 12  $\Omega$  @ V<sub>GS</sub> = -2.5 V
- ESD protection diode (note 3)
- RoHS Compliant



Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	7/7	Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		- 20	V
$V_{GSS}$	Gate-Source Voltage		± 8	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	<b>– 150</b>	mA
	– Pulsed		<b>– 1000</b>	
$P_D$	Power Dissipation (Steady State)	(Note 1a)	625	mW
SY		(Note 1b)	446	
$T_J$ , $T_{STG}$	T <sub>J</sub> , T <sub>STG</sub> Operating and Storage Junction Temperature Range		−55 to +150	°C

### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	200	°C/W
Rou	Thermal Resistance, Junction-to-Ambient (Note 1b)	280	

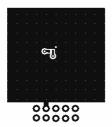
**Package Marking and Ordering Information** 

_	Device Marking	Device	Reel Size	Tape width	Quantity
	В	FDY101PZ	7"	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = -250 \mu\text{A}$	- 20			V
ΔBV <sub>DSS</sub> ΔT,j	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$ , Referenced to 25°C		15		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V},  V_{GS} = 0 \text{ V}$			- 3	μΑ
$I_{GSS}$	Gate-Body Leakage,	$V_{GS} = \pm 8 \text{ V},  V_{DS} = 0 \text{ V}$			± 10	μΑ
On Chara	acteristics (Note 2)					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_{D} = -250 \ \mu A$	- 0.65	-1.0	- 1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		-3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$\begin{split} &V_{GS} = -4.5 \text{ V},  I_D = -150 \text{ mA} \\ &V_{GS} = -2.5 \text{ V},  I_D = -125 \text{ mA} \\ &V_{GS} = -1.8 \text{ V},  I_D = -100 \text{ mA} \\ &V_{GS} = -1.5 \text{ V},  I_D = -30 \text{ mA} \\ &V_{GS} = -4.5 \text{ V},  I_D = -150 \text{mA}, \\ &T_J = 125^{\circ}\text{C} \end{split}$		N	8 12 15 20 12	Ω
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 \text{ V},  I_{D} = -150 \text{ mA}$	. 0/	0.7		S
Dynamic	Characteristics			0.17		14
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V},  V_{GS} = 0 \text{ V},$	10	100	11	pF
Coss	Output Capacitance	f = 1.0 MHz	O,	30		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	EWILK		15		pF
Switchin	g Characteristics (Note 2)	100,100,100,100,100,100,100,100,100,100	SO,			
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -10 \text{ V},  I_D = -0.5 \text{ A},$		6	12	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		13	23	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	1,7P201		8	16	ns
t <sub>f</sub>	Turn-Off Fall Time	ON'ICH		1	2	ns
$Q_g$	Total Gate Charge	$V_{DS} = -10 \text{ V},  I_D = -150 \text{ mA},$		1.0	1.4	nC
$Q_{gs}$	Gate-Source Charge	$V_{GS} = -4.5 \text{ V}$		0.2		nC
$Q_{gd}$	Gate-Drain Charge	Kr.		0.3		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
$V_{SD}$	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V},  I_{S} = -150 \text{ mA}(\text{Note 2})$		- 0.8	- 1.2	V
ı,	Diode Reverse Recovery Time	$I_F = -150 \text{ mA},$		11		ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/μs		2		nC

#### Notes

1. R<sub>8JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>8JO</sub> is guaranteed by design while R<sub>8CA</sub> is determined by the user's board design.



a) 200°C/W when mounted on a 1in² pad of 2 oz copper



- b) 280°C/W when mounted on a minimum pad of 2 oz copper Scale 1 : 1 on letter size paper
- 2. Pulse Test: Pulse Width <  $300\mu s$ , Duty Cycle < 2.0%
- The diode connected between the gate and source serves only as protection againts ESD. No gate overvoltage rating is implied.

### **Typical Characteristics**

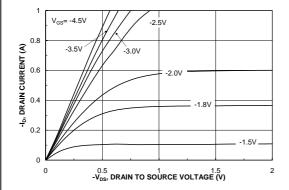


Figure 1. On-Region Characteristics.

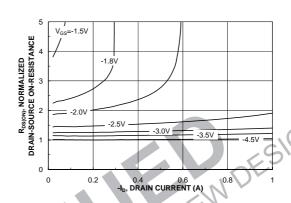
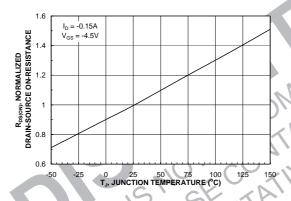


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.



igure 3. On-Resistance Variation with Temperature.

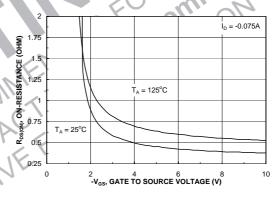


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

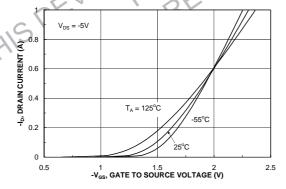


Figure 5. Transfer Characteristics.

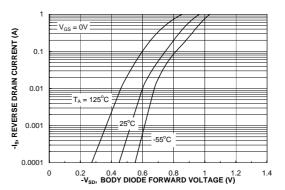


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

### **Typical Characteristics**

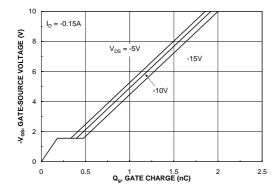


Figure 7. Gate Charge Characteristics.

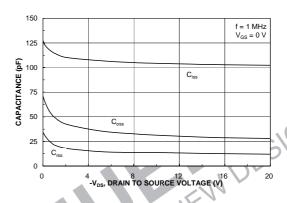


Figure 8. Capacitance Characteristics.

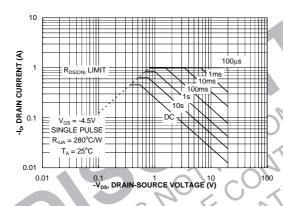


Figure 9. Maximum Safe Operating Area.

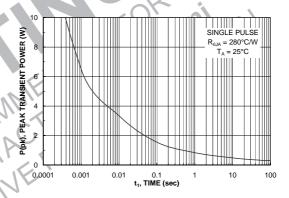


Figure 10. Single Pulse Maximum Power Dissipation.

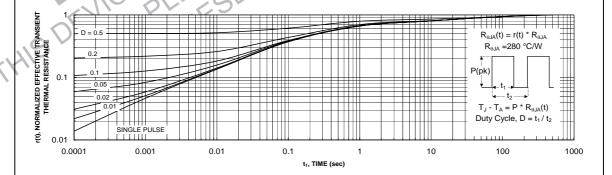
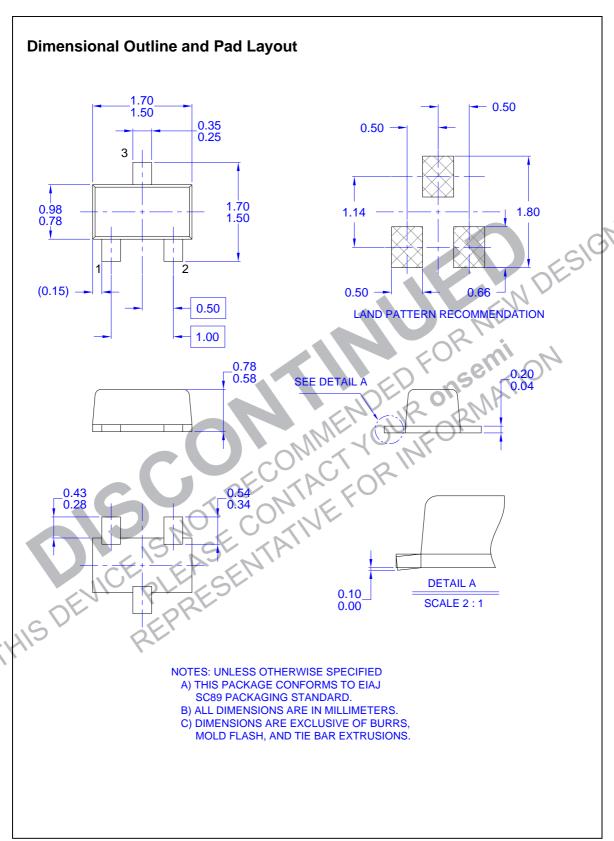


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.



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